Joint IEEE P802.3ct / P802.3cw Task Force Feb 18, 2021 Interim Teleconference Meeting Unapproved Meeting Minutes, Prepared by John D'Ambrosia Meeting called to order at 10:02 am ET (all times ET)

Chair noted that individuals should fill out IMAT information for attendance. Chair also reminded individuals to check their affiliation.

Chair noted that there is currently winter storm going through his area that has potential to cause power / internet outage. Chair noted that if he gets disconnected from the call, that Tom Issenhuth, is to chair the call in his absence.

Presentation #1 Agenda and General Information

Presenter: John D'Ambrosia

URL: https://www.ieee802.org/3/ct/public/tf_interim/21_0218/agenda_3ctcw_210218.pdf

Chair presented agenda and asked if there were any objections to the agenda. There were none and the agenda was considered approved.

2/15 minutes - https://www.ieee802.org/3/ct/public/tf interim/21 0215/minutes 3ctcw 210215 unapproved.pdf

Chair asked if anyone had any modifications for the noted minutes. There were no requests.

Chair asked if there were any objections to the approval of the minutes. There were none, and the minutes were considered approved.

Chair noted that the agenda deck had been sent out, and requested that individuals review the following IEEE SA policies prior to the interim meeting –

- IEEE SA Participation Policy
- IEEE SA Copyright Policy
- IEEE SA Patent Policy

Chair presented IEEE SA Participation Policy.

Chair presented IEEE SA Copyright Policy.

Chair presented IEEE SA Patent Policy. Chair did call for Potentially Essential Patents, and no one came forward.

Chair reviewed Requesting Conditional Approval and noted the need for another potential meeting before the IEEE 802.3 March Plenary Closing Meeting on Mar 18. Chair took following straw poll

I would prefer an addition meeting to address comments on IEEEE P802.3ct D3.1 be held

- a) After 1pm ET on a Monday through Thursday prior to Mar 18
- b) From 10am to 1pm on Friday March 5, 2021
- c) Not be scheduled.

Results

- a) 10
- b) 19
- c) 0

Chair noted that there were no votes to not schedule a meeting and thanked the TF for recognizing the situation. Based on the straw poll, the chair will schedule a call for March 5, 2021 from 10am to 1pm ET.

Presentation #2 Chief Editor's Report

Presenter Tom Issenhuth

URL https://www.ieee802.org/3/ct/public/tf interim/21 0218/issenhuth 3ct 01 210218.pdf

Presentation #3 Terminology (Part II) Ad hoc Report

Presenter Gary Nicholl

URL https://www.ieee802.org/3/ct/public/tf interim/21 0218/stassar 3ct 01a 210218.pdf

Chair noted that the original charter of the ad hoc was to bring recommendations back to the TF on the 2/18 teleconference. The presentation is requesting additional time

Comment consideration for comment submitted against D3.1 began ≈10:50am.

During consideration R1-46, the terminology proposed in the Terminology (Part II) ad hoc report was reviewed and discussed. The following presentation summarizes the task force discussion.

Presentation #4 Task Force Discussion - Terminology (Part II) Ad hoc Report

Presenter Tom Issenhuth

URL https://www.ieee802.org/3/ct/public/tf interim/21 0218/issenhuth 3ct 02 210218.pdf

Straw Poll #2 during consideration of R1-46

I support the following definition for "DWDM black link:

- a) An aggregate of pairs of DWDM channels, with each pair supporting one full-duplex connection
- b) An aggregate of pairs of DWDM channels, with each pair supporting one full-duplex connection where the implementation of the transmission paths is not specified
- c) An aggregate of pairs of DWDM channels (specified using the black link approach), with each pair supporting one full-duplex connection.

Results

- a) 5
- b) 9
- c) 6

Meeting break at 12:02 pm

Meeting reconvened at 12:07 pm

Comment consideration ended at 1:00 pm.

Chair reviewed future meetings and noted the addition of the 05 Mar meeting.

Meeting adjourned at ≈1:01 pm.

Attendees (per IMAT)

Name	Employer	Affiliation
Anslow, Peter	Independent	Independent
Bruckman, Leon	HUAWEI	HUAWEI
Chang, Yongmao	Inphi Corporation	Source Photonics
D'Ambrosia, John	Futurewei	Futurewei, US Subsidiary of Huawei
Dawe, Piers J G	Mellanox Technologies	Nvidia
Deandrea, John	Finisar Corporation	Finisar Corporation
Geng, Limin	HUAWEI	HUAWEI
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Inphi
Huber, Thomas	Nokia	Nokia
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies
Lewis, Jon	Dell EMC	Dell EMC
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.
Malicoat, David	Malicoat Networking Solutions	Malicoat Networking Solutions; SENKO
		Advanced Components
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.
Omori, Kumi	NEC Corporation	NEC Corporation
PARK, CHUL SOO		Juniper Networks, Inc.
Pittala, Fabio	Huawei Technologies Duesseldorf GmbH	Huawei Technologies Duesseldorf GmbH
Ran, Adee	Intel Corporation	Intel Corporation
Sarlet, Gert	II-VI Incorporated	II-VI Incorporated
Schmitt, Matthew	Cable Television Laboratories Inc.	Cable Television Laboratories Inc.
	(CableLabs)	(CableLabs)
She, Qingya	Fujitsu Network Communications	Fujitsu Network Communications
Sluyski, Michael	Acacia Communications	Acacia Communications
Sone, Yoshiaki	NTT	Nippon Telegraph and Telephone
		Corporation (NTT)
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDIRES
Sprague, Edward	Infinera Corporation	Infinera Corporation
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd
Sun, Junqing	Credo Semiconductor	Credo Semiconductor
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LIMITED
Trowbridge, Stephen	Nokia	Nokia
Young, James	CommScope, Inc.	CommScope
Zhang, Bo	Inphi Corporation	Inphi Corporation